Texas Instruments Inc. (DUNS# 00-732-1904) Supplier Name:

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

05/17/2022

## Details for "PCA9555DWR"

### **Current Product Information**

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package   Pins	Package body size (mm)	Total device mass (mg)*
PCA9555DWR	NIPDAU	Level-1-260C-UNLIM	TI TAIWAN A/T	DW   24	7.52x15.36x2.35	955.8

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

## **Environmental Ratings Information**

RoHS		REACH	Green	IEC 62474 DB	
	Yes	Yes	Yes	Yes	

## **Component Information**

				Homoge	neous Material Level	Component Level		
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm	
Bond Wire								
Copper and Its Alloys	Iron	7439-89-6	0.000001	0.000273	3	0	0	
Other Nonferrous Metals and Alloys	Calcium	7440-70-2	0.000001	0.000273	3	0	0	
Other Nonferrous Metals and Alloys	Yttrium	7440-65-5	0.000003	0.000819	8	0	0	
Precious Metals	Gold	7440-57-5	0.366285	99.997543	999975	0.038321	383	
Precious Metals	Silver	7440-22-4	0.000004	0.001092	11	0	0	
Sub-Total			0.366294	100	1000000	0.038322	383	
Die Attach Adhesive								
Precious Metals	Silver	7440-22-4	0.459529	80.000035	800000	0.048077	481	
Thermoplastics	Ероху	85954-11-6	0.114882	19.999965	200000	0.012019	120	
Sub-Total			0.574411	100	1000000	0.060096	601	
Lead Frame								
Copper and Its Alloys	Copper	7440-50-8	432.933159	97.05	970500	45.294241	452942	
Copper and Its Alloys	Iron	7439-89-6	11.598415	2.6	26000	1.213447	12134	
Copper and Its Alloys	Phosphorus	7723-14-0	0.669139	0.15	1500	0.070007	700	
Zinc and Its Alloys	Zinc	7440-66-6	0.892186	0.2	2000	0.093342	933	
Sub-Total			446.092899	100	1000000	46.671037	466710	
Lead Frame Plating								
Nickel and Its Alloys	Nickel	7440-02-0	1.475311	95.119987	951200	0.15435	1543	
Precious Metals	Gold	7440-57-5	0.012098	0.780013	7800	0.001266	13	
Precious Metals	Palladium	7440-05-3	0.063591	4.1	41000	0.006653	67	
Sub-Total			1.551	100	1000000	0.162268	1623	
Mold Compound	•	*			•			
Other Inorganic Materials	Fused Silica	60676-86-0	444.716165	88	880000	46.527	465270	
Other Plastics and Rubber	Carbon Black	1333-86-4	1.516078	0.3	3000	0.158615	1586	
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	2.779476	0.55	5500	0.290794	2908	
Thermoplastics	Epoxy	85954-11-6	56.34756	11.15	111500	5.895182	58952	
Sub-Total			505.359279	100	1000000	52.871591	528716	
Semiconductor Device	•							
Ceramics / Glass	Doped Silicon	7440-21-3	1.879968	100	1000000	0.196686	1967	
Sub-Total			1.879968	100	1000000	0.196686	1967	
Total			955.823851		-	100	1000000	

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.

See Glossary of Terms for more details.

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

# **Product Content Methodology**

For an explanation of the methods used to determine material weights, See Product Content Methodology

## Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

# Important Information/Disclaimer

Tibases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. Tl and Tl suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by Tl. The material content information is

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 05/17/2022

ROHS: Means TI semiconductor products that are compliant with the current ROHS requirement that the maximum concentration values of the ten substances listed in ROHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (5b203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.